SN54166, SN54LS166A, SN74166, SN74LS166A PARALLEL-LOAD 8-BIT SHIFT REGISTERS

OCTOBER 1976 - REVISED MARCH 1988

- Synchronous Load
- Direct Overriding Clear
- Parallel to Serial Conversion

ТҮРЕ	TYPICAL MAXIMUM CLOCK FREQUENCY	TYPICAL POWER DISSIPATION
′166	35 MHz	360 mW
'LS166A	35 MHz	100 mW

description

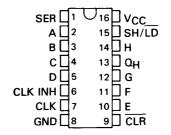
The '166 and 'LS166A 8-bit shift registers are compatible with most other TTL logic families. All '166 and 'LS166A inputs are buffered to lower the drive requirements to one Series 54/74 or Series 54LS/74LS standard load, respectively. Input clamping diodes minimize switching transients and simplify system design.

These parallel-in or serial-in, serial-out shift registers have a complexity of 77 equivalent gates on a monolithic chip. They feature gated clock inputs and an overriding clear input. The parallel-in or serial-in modes are established by the shift/load input. When high, this input enables the serial data input and couples the eight flip-flops for serial shifting with each clock pulse. When low, the parallel (broadside) data inputs are enabled and synchronous loading occurs on the next clock pulse. During parallel loading, serial data flow is inhibited. Clocking is accomplished on the low-to-high-level edge of the clock pulse through a two-input positive NOR gate permitting one input to be used as a clock-enable or clock-inhibit function. Holding either of the clock inputs high inhibits clocking; holding either low enables the other clock input. This, of course, allows the system clock to be free-running and the register can be stopped on command with the other clock input. The clock inhibit input should be changed to the high level only while the clock input is high. A buffered, direct clear input overrides all other inputs, including the clock, and sets all flip-flops to zero.

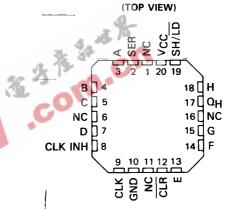
FUNCTION TABLE

		IN	PUTS			INTE	RNAL	ОПТРИТ
CLEAR	SHIFT/	CLOCK	CLOCK	SERIAL	PARALLEL	ουτι	PUTS	
CLEAN	LOAD	INHIBIT	CLUCK	SENIAL	AH	Q_A Q_B		σH
L	X	×	Х	Х	×	L	L	L
Н	×	L	L	×	×	QAO	σ_{B0}	QH0
н	L	Ł	1	×	a h	а	b	h
Н	н	L	1	н	×	н	\mathtt{q}_{An}	q_{Gn}
н	н	L	t	L	Х	L	\mathbf{Q}_{An}	a_{Gn}
н	x	Н	1	×	Х	Q _{A0}	a_{B0}	σ_{H0}

SN54166, SN54LS166A . . . J OR W PACKAGE SN74166 . . . N PACKAGE SN74LS166A . . . D OR N PACKAGE (TOP VIEW)

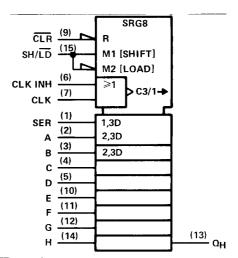


SN54LS166A . . . FK PACKAGE



NC - No internal connection

logic symbol[†]

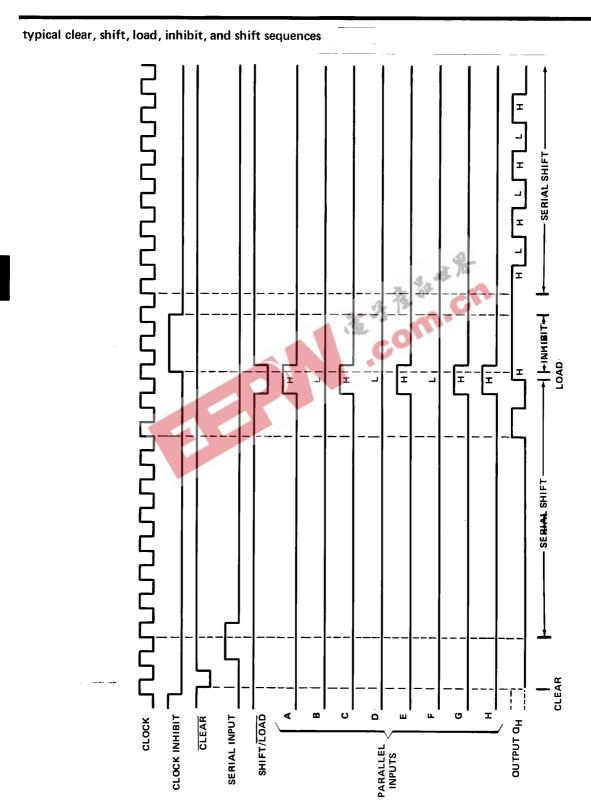


[†]This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

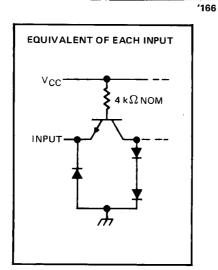
Pin numbers shown are for D, J, N, and W packages.

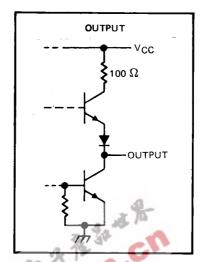
PRODUCTION DATA documents contain information current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warrenty. Production processing does not necessarily include testing of all parameters.

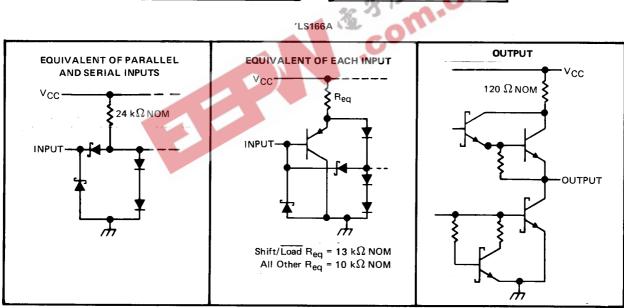




schematics of inputs and outputs

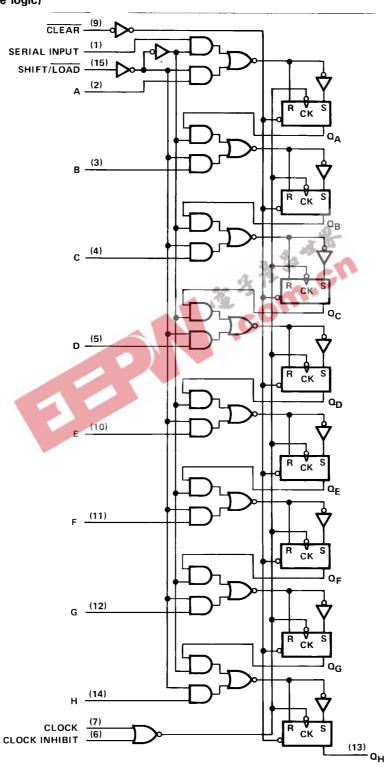






SN54166, SN54LS166A, SN74166, SN74LS166A PARALLEL-LOAD 8-BIT SHIFT REGISTERS

logic diagram (positive logic)



Pin numbers shown are for D, J, N, and W packages.



SN54166, SN74166 PARALLEL-LOAD 8-BIT SHIFT REGISTERS

olute maximum ratings over oper	ating free	air te	mpera	ature	rar	ge	(unl	ess	ot	hei	wi	se	no	te	d)				
Supply voltage, V _{CC} (see Note 1)																			
Input voltage																			Ę
Operating free-air temperature range	: SN54166	(see N	Note 2	١												-5	55°C	C to	1
	SN74166																0°	C t	Ю.
Storage temperature range																-6	5°C	C to	, 1

recommended operating conditions

		SN54166			SN74166			
	MIN	NOM	MAX	MIN	NOM	MAX	TINU	
Supply voltage, V _{CC}	4.5	5	5.5	4.75	5	5.25	V	
High-level output current, IOH			-800			-800	μΑ	
Low-level output current, IOL			16			16	mA	
Clock frequency, f _{clock}	0		25	0		25	MHz	
Width of clock or clear pulse, tw (see Figure 1)	20	-		20			ns	
Mode-control setup time, t _{su}	30	- 9	1	30			ns	
Data setup time, t _{SU} (see Figure 1)	20	70.		20			ns	
Hold time at any input, th (see Figure 1)	0		- 16.00	0			ns	
Operating free-air temperature, TA (see Note 2)	-55		125	0		70	°C	

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	DADAMETER	TEST CONDITIONS†	SN54166	SN74166	
	PARAMETER	TEST CONDITIONS.	MIN TYP# MA	X MIN TYP	MAX
ViH	High-level input voltage		2	2	V
VIL	Low-level input voltage		(8.0	0.8 V
VIĶ	Input clamp voltage	V _{CC} = MIN, I _I = -12 mA		.5	-1.5 V
VOH	High-level output voltage	V _{CC} = MIN, V _{IH} = 2 V,	2.4 3.4	2,4 3,4	V
- 011	This is a super strength	$V_{1L} = 0.8 \text{ V}, I_{OH} = -800 \mu\text{A}$		2.1, 0.4	
VOL	Low-level output voltage	$V_{CC} = MIN, V_{IH} = 2V,$	0.2	0.4 0.2	0.4 V
	,	V _{IL} = 0.8 V, I _{OL} = 16 mA		5.2	
ի	Input current at maximum input voltage	$V_{CC} = MAX, V_1 = 5.5 V$		1	1 mA
ЧН	High-level input current	V _{CC} = MAX, V _I = 2.4 V		40	40 µA
ΗL	Low-level input current	V _{CC} = MAX, V _I = 0.4 V		.6	-1.6 mA
los	Short-circuit output current§	V _{CC} = MAX	-20 -	57 –18	−57 mA
Icc	Supply current	V _{CC} = MAX, See Note 3	90 1	27 90	127 mA

[†]For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

- NOTES: 1. Voltage values are with respect to network ground terminal.
 - 2. An SN54166 in the W package operating at free-air temperatures above $113^{\circ}C$ requires a heat-sink that provides a thermal resistance from case to free air, $R_{\theta CA}$, of not more than $48^{\circ}C/W$.
 - 3. With all outputs open, 4.5 V applied to the serial input, all other inputs except the clock grounded, I_{CC} is measured after a momentary ground, then 4.5 V, is applied to the clock.

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ} \text{ C}$

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
f _{max}	Maximum clock frequency		25	35		MHz
Propagation delay time, high-to- tPHL low-level output from clear			23	35		
	$C_1 = 15 pF$, $R_1 = 400 \Omega$,		23	35	ns	
	Propagation delay time, high-to-			- 20		
[†] PHL low-level output from clock	See Figure 1		20	30	ns	
	Propagation delay time, low-to-					
tPLH	high-level output from clock			17	26	ns



[‡]All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

Not more than one output should be shorted at a time.

SN54LS166A, SN74LS166A PARALLEL-LOAD 8-BIT SHIFT REGISTERS

Supply voltage, VCC (see Note 1).			7 V
Input voltage	• • • • • • • • • • • • • • • • • • • •		7 V
Operating free-air temperature range			
	SN74LS166A		0°C to 70°C
Storage temperature range		_ 65°	°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

		SI	N54LS1	66A	SI	174LS1	66A	
		MIN	TYP	MAX	MIN	TYP	MAX	UNIT
VCC	Supply voltage	4.5	5	5.5	4.75	5	5.25	V
v_{IH}	High-level input voltage	2			2			V
VIL	Low-level input voltage			0.7			0.8	V
Юн	High-level output current			- 0.4			- 0.4	mA
loL	Low-level output current			4			8	mA
^f clock	Clock frequency	0		25	0		25	MHz
t _w	Width of clear pulse (See Figure 1)	20	3	- 15	20			ns
t _w	Width of clock pulse (See Figure 1)	25	3,5		25			
t _{su}	Mode-control setup time	30	36	~ 1	30		,, <u></u>	ns
t _{su}	Data setup time (See Figure 1)	20	-	0	20			ns
th	Hold time at any input (See Figure 1 and Note 4)	0	47	-	0			ns
TA	Operating free air temperature	- 55	100	125	0		70	°c

NOTE 4: The hold time limit of 0 ns applies only if the rise time is less than or equal to 10 ns.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS †		18	154LS16	36A	SN	66A	UNIT		
TANAMETER	TEST CONDITIO	5143	MIN	TYP‡	MAX	MIN	TYP‡	MAX	וואטן	
٧ıĸ	$V_{CC} = MIN$, $I_{I} = -18 \text{ mA}$				- 1.5			- 1.5	V	
Voн	$V_{CC} = MIN,$ $V_{IH} = 2 V,$ $I_{OH} = -0.4 \text{ mA}$	V _{IL} = MAX,	2.5	3.4		2.7	3.4		V	
V	V _{CC} = MIN, V _{IH} = 2 V,	IOL = 4 mA		0.25	0.4		0.25	0.4	—	
VOL	V _{IL} = MAX	IOL = 8 mA					0.35	0.5	 	
l _I	V _{CC} = MAX, V _I = 7 V				0.1			0.1	mA	
ЧΗ	$V_{CC} = MAX$, $V_I = 2.7 V$				20			20	μΑ	
IIL	V _{CC} = MAX, V _I = 0.4 V				- 0.4		•	- 0.4	mA	
los§	V _{CC} = MAX		- 20		– 100	- 20		- 100	mA	
'cc	V _{CC} = MAX, See Note 5			20	32		20	32	mA	

†For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions. \pm All typical values are at V_{CC} = 5 V, T_A = 25°C.

§Not more than one output should be shorted at a time, and duration for short-circuit should not exceed one second.

NOTE 5: With all outputs open, 4.5 V applied to the serial input and all other inputs except the clock grounded, I_{CC} is measured after a momentary ground, than 4.5 V, is applied to clock.

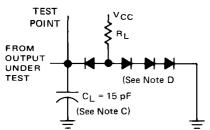
switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
fmax	Maximum clock frequency		25	35	-	MHz
	Propagation delay time, high-to-					
^t PHL	low-level output from clear	0 45 5 0 010		19	30	ns
*=	Propagation delay time, high-to-	$C_L = 15 \mathrm{pF}, R_L = 2 \mathrm{k}\Omega,$		4.4		
^t PHL	low-level output from clock	See Figure 1	,	14	25	ns
+	Propagation delay time, low-to-					
^t PLH	high-level output from clock		5	11	20	ns



10 8 3

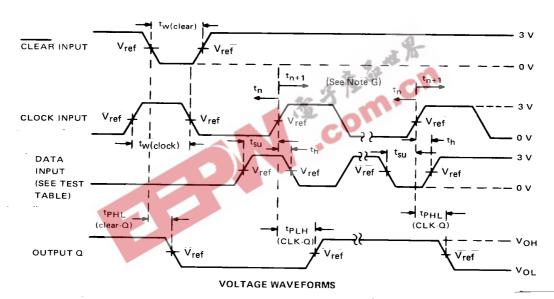
PARAMETER MEASUREMENT INFORMATION



LOAD FOR OUTPUT UNDER TEST

TEST TABLE FOR SYNCHRONOUS INPUTS

DATA INPUT FOR TEST	SHIFT/LOAD	OUTPUT TESTED (SEE NOTE F)
Н	0 V	QH at tn+1
Serial Input	4.5 V	Он at t _{n+8}



- NOTE: A. All pulse generators have the following characteristics: $Z_{OUt} \approx 50Q$; for '166, $t_r \le 7$ ns and $t_f \le 7$ ns; for 'LS166A, $t_r \le 15$ ns and $t_f \le 6$ ns.
 - B. The clock pulse has the following characteristics: $t_{W(clock)} \le 20$ ns and PRR = 1 MHz. The clear pulse has the following characteristics: $t_{W(clear)} \le 20$ ns and $t_{hold} = 0$ ns. When testing t_{max} , vary the clock PRR.
 - C. C_L includes probe and jig capacitance.
 - D. All diodes are 1N3064, 1N916, or equivalent.
 - E. A clear pulse is applied prior to each test.
 - F. Propagation delay times (t_{pLH}) and t_{pHL} are measured at t_{n+1} . Proper shifting of data is verified at t_{n+8} with a functional test.
 - G. t_n = bit time before clocking transition
 - t_{n+1} = bit time after one clocking transition
 - tn+8 = bit time after eight clocking transitions
 - H. For '166 $V_{ref} = 1.5 V$; for 'LS166A $V_{ref} = 1.3 V$.

FIGURE 1





26-Sep-2005

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
5962-9558301QEA	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
5962-9558301QFA	ACTIVE	CFP	W	16	1	TBD	Call TI	Level-NC-NC-NC
5962-9558301QFA	ACTIVE	CFP	W	16	1	TBD	Call TI	Level-NC-NC-NC
8001701EA	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
8001701EA	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
8001701FA	ACTIVE	CFP	W	16	1	TBD	Call TI	Level-NC-NC-NC
8001701FA	ACTIVE	CFP	W	16	1	TBD	Call TI	Level-NC-NC-NC
JM38510/30609B2A	ACTIVE	LCCC	FK	20	1	TBD	Call TI	Level-NC-NC-NC
JM38510/30609B2A	ACTIVE	LCCC	FK	20	1	TBD	Call TI	Level-NC-NC-NC
JM38510/30609BEA	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
JM38510/30609BEA	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
JM38510/30609BFA	ACTIVE	CFP	W	16	1	TBD	Call TI	Level-NC-NC-NC
JM38510/30609BFA	ACTIVE	CFP	W	16	1	TBD	Call TI	Level-NC-NC-NC
SN54166J	ACTIVE	CDIP	J	16	175.	TBD 🧥	Call TI	Level-NC-NC-NC
SN54166J	ACTIVE	CDIP	J	16	1/2	TBD	Call TI	Level-NC-NC-NC
SN54LS166AJ	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
SN54LS166AJ	ACTIVE	CDIP	J	16	<u>_00</u>	TBD	Call TI	Level-NC-NC-NC
SN74166N	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74166N	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74166N3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74166N3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74LS166AD	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS166AD	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS166ADE4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS166ADE4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS166ADR	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS166ADR	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS166ADRE4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS166ADRE4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS166AJ	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI
SN74LS166AJ	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI
SN74LS166AN	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74LS166AN	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74LS166AN3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74LS166AN3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI



PACKAGE OPTION ADDENDUM

26-Sep-2005

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
SN74LS166ANSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS166ANSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS166ANSRE4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS166ANSRE4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SNJ54166J	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
SNJ54166J	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
SNJ54166W	ACTIVE	CFP	W	16	1	TBD	Call TI	Level-NC-NC-NC
SNJ54166W	ACTIVE	CFP	W	16	1	TBD	Call TI	Level-NC-NC-NC
SNJ54LS166AFK	ACTIVE	LCCC	FK	20	1	TBD	Call TI	Level-NC-NC-NC
SNJ54LS166AFK	ACTIVE	LCCC	FK	20	1	TBD	Call TI	Level-NC-NC-NC
SNJ54LS166AJ	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
SNJ54LS166AJ	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
SNJ54LS166AW	ACTIVE	CFP	W	16	13%	TBD 🔨	Call TI	Level-NC-NC-NC
SNJ54LS166AW	ACTIVE	CFP	W	16	火门	TBD	Call TI	Level-NC-NC-NC

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

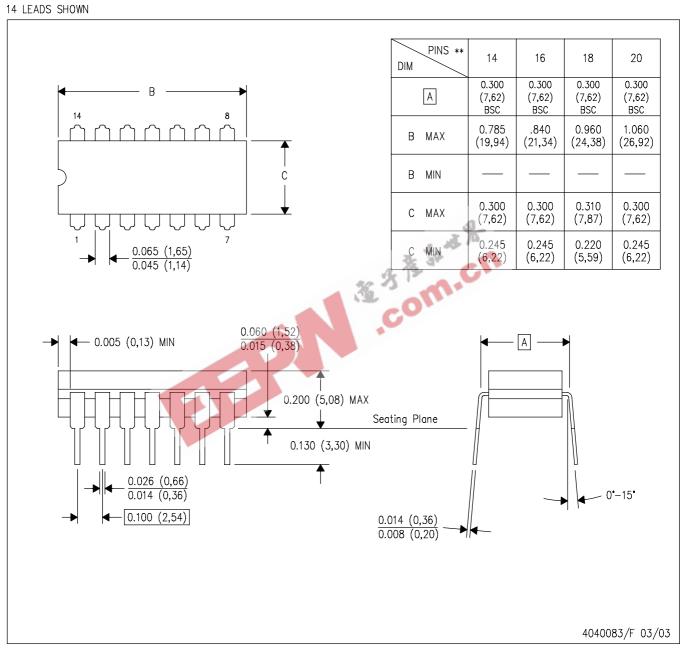
Pb-Free (RoHS): Ti's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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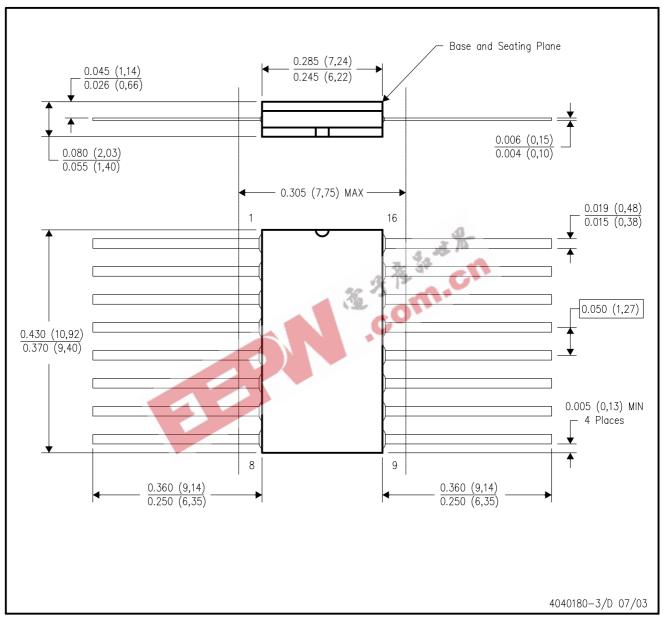
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- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

W (R-GDFP-F16)

CERAMIC DUAL FLATPACK



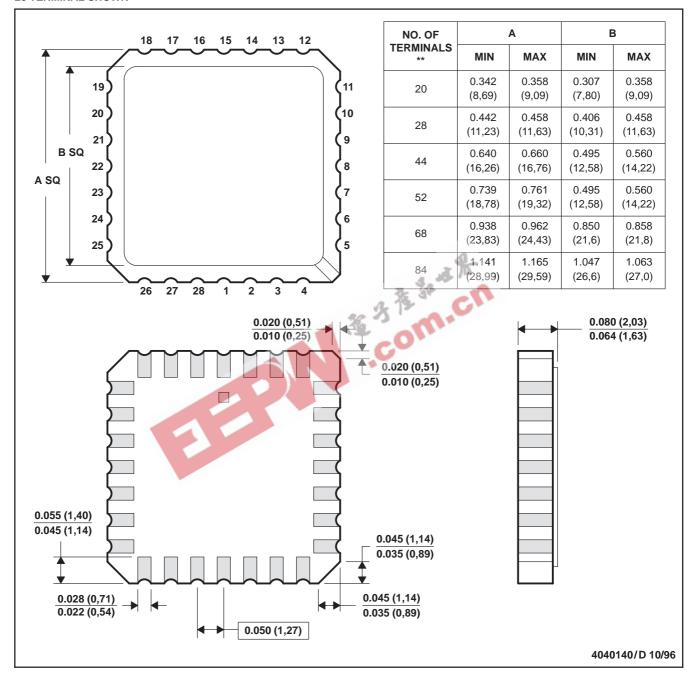
- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within MIL STD 1835 GDFP1-F16 and JEDEC MO-092AC



FK (S-CQCC-N**)

28 TERMINAL SHOWN

LEADLESS CERAMIC CHIP CARRIER



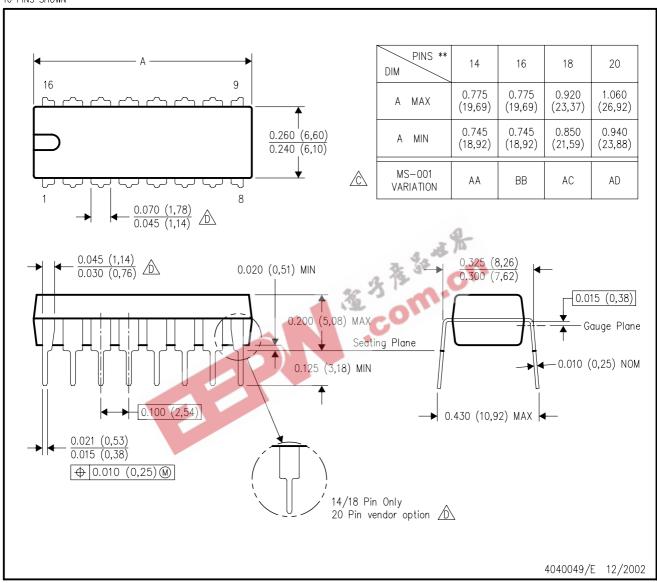
- NOTES: A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. This package can be hermetically sealed with a metal lid.
 - D. The terminals are gold plated.
 - E. Falls within JEDEC MS-004



N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN

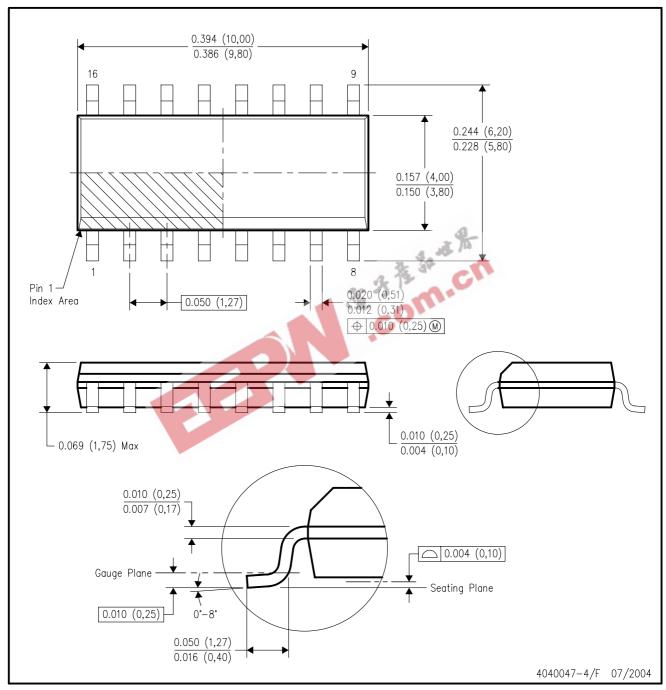


- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



D (R-PDSO-G16)

PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-012 variation AC.

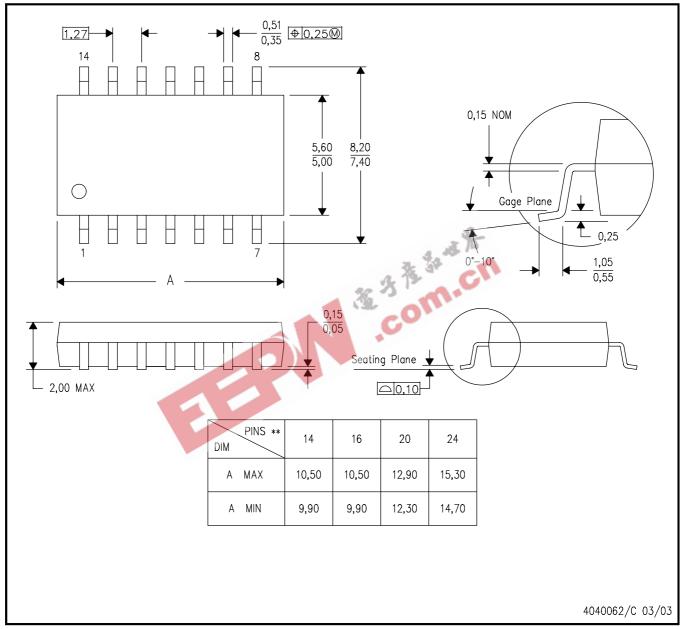


MECHANICAL DATA

NS (R-PDSO-G**)

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



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